



SPECIFICATION

产品规格书

Model产品型号: BTP-LC-QMV01

Version版本型号: V1.1

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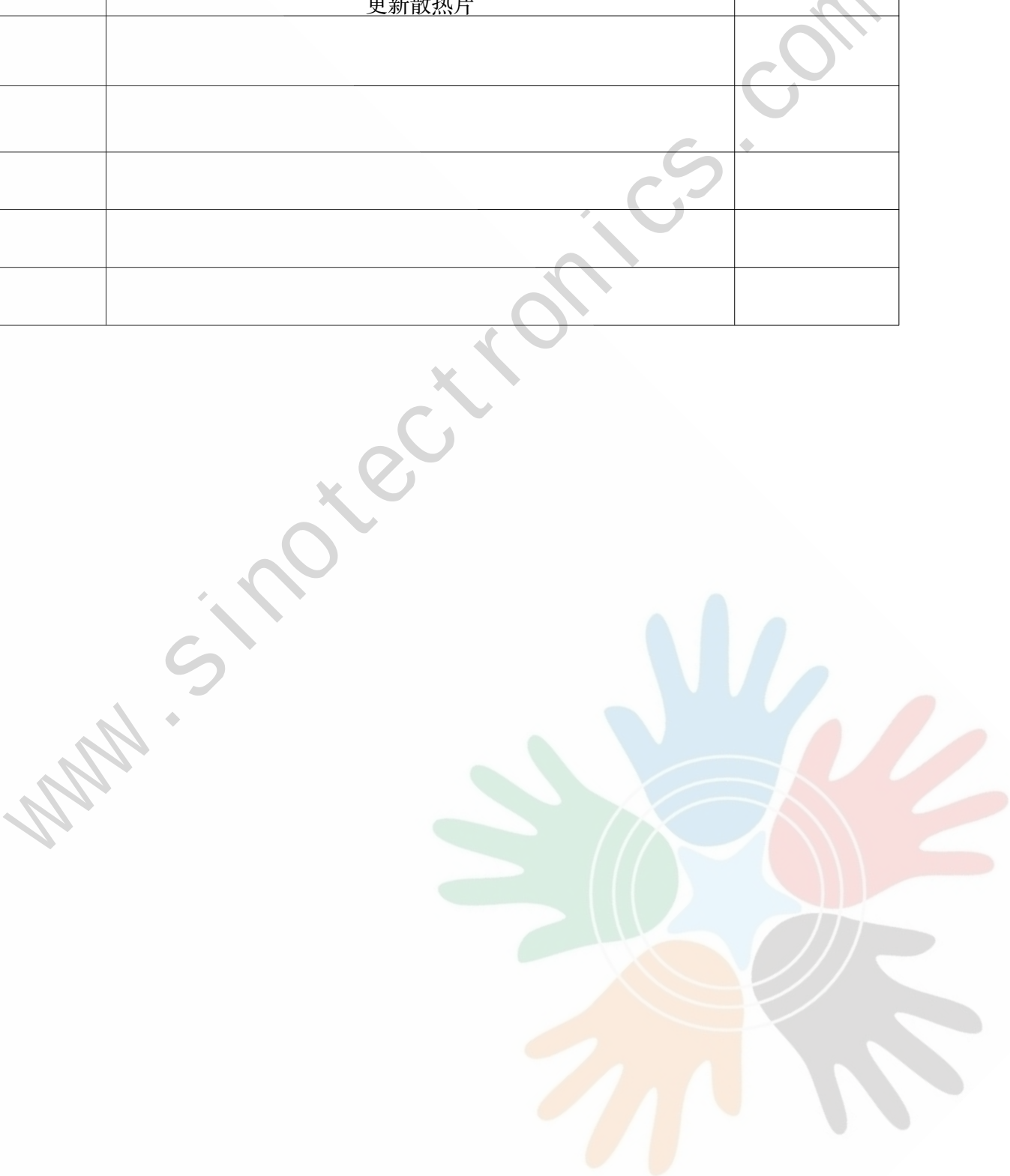


Content(目录)

1.General Description(概述)	1
2.Configuration & General Precautions(使用注意事项)	2
3. Main features (主要特性)	3
4. BOARD PICTURE(板卡外观图)	4
5.PCB Dimension(结构尺寸图)	5
6.Schematics Of IR Board & Key Board (遥控&按键的原理图)	6
7.Interface Definition(接口定义)	6
7.1 JP8(10PIN/2.0): IR & KEY BOARD CONNECTOR(按键控制接口)	6
7.2 CNF1(I-RE51S-HF 接口 0.5mm 间距 51PIN): VByOne/eDP (信号输出接口)	7
7.3 JP7(6PIN/2.0): INVERTER CONNECTOR (背光接口)	9
7.4 JP5 (4PIN/2.0): SPEAKER (喇叭接口)	9
7.5 JP1(10PIN/2.54) External Power Input Definition(供电接口)	10
7.6 JP9 (4PIN/2.0): UART (串口接口)	10
8.Packaging method(包装方式)	11
9.Environment Test Report(环境实验报告).....	12/18

Revision History

VERSION	DESCRIPTION	DATE
V1.0	First issued 首次发行	2017.07.26
V1.1	Update Heat Sink 更新散热片	2024.07.02





1.General Description(概述)

BTP-LC-QMV01 is a motherboard with LCD driver.

This motherboard is suitable for LCD panels with dedicated EDP interfaces. It is compatible with most 4LANE EDP/8LANE EDP OR V-BY-ONE screens and can be connected by FFC. The resolution can be up to 4096X2160@60Hz.

The motherboard supports HDMI*2, DP* 1 input, HDMI supports 2.0 standard (HDCP2.2), and DP supports DP1.2 standard.

BTP-LC-QMV01 是一款液晶显示器驱动主板。

该主板适用于 EDP 专用接口的液晶面板，兼容了大部分 4LANE EDP/8LANE EDP;V-BY-ONE 屏，可以用 FFC 来连接，分辨率最高支持到带宽 4096X2160@60Hz。

主板支持 HDMI*2,DP*1 输入，HDMI 支持 2.0 标准（HDCP2.2），DP 支持 DP1.2 标准。



2.Configuration & General Precautions(使用注意事项)

- For safety issue, please keep the board 6.0mm away from metal parts of the TV at least.
- 基于安全考虑, 请在安装时确保板卡与其他金属材料保持6.0mm 以上的距离。
- Protect the board from static electrostatic in care of damage to the IC.
- 请使板卡远离静电以免损坏IC。
- Keep the board away from conductor when it is working.
- 确保板卡工作时远离导体。
- Don't press, distort or disassemble the board.
- 请勿强压、扭曲或拆解板卡。
- Clean the board with soft dry cloth when it's dirty.
- 若板卡有污渍, 请用干布擦拭。
- Don't switch on the power supply before panel is correctly connected.
- 正确连接好屏线前请勿通电。
- Relative humidity: $\leq 80\%$.
- 相对湿度: $\leq 80\%$ 。
- Storage temperature: $-40 \sim 60^{\circ}\text{C}$.
- 储存温度: $-40 \sim 60^{\circ}\text{C}$ 。
- Operation temperature: $-10 \sim 40^{\circ}\text{C}$.
- 工作温度: $-10 \sim 40^{\circ}\text{C}$ 。
- The brightness of panel is influenced greatly by temperature, you should measure it after power on 10~30 minutes.
- 因屏的亮度易受温度影响, 请在开机10~30 分钟后再测量。
- Keep the board surface clean. Check the appearance of the board if there has any defective parts, such as damaged, weighty nick, etc.
- 保持产品表面整洁。检查产品外观是否有明显品质不良存在, 如: 破损, 严重划痕等。

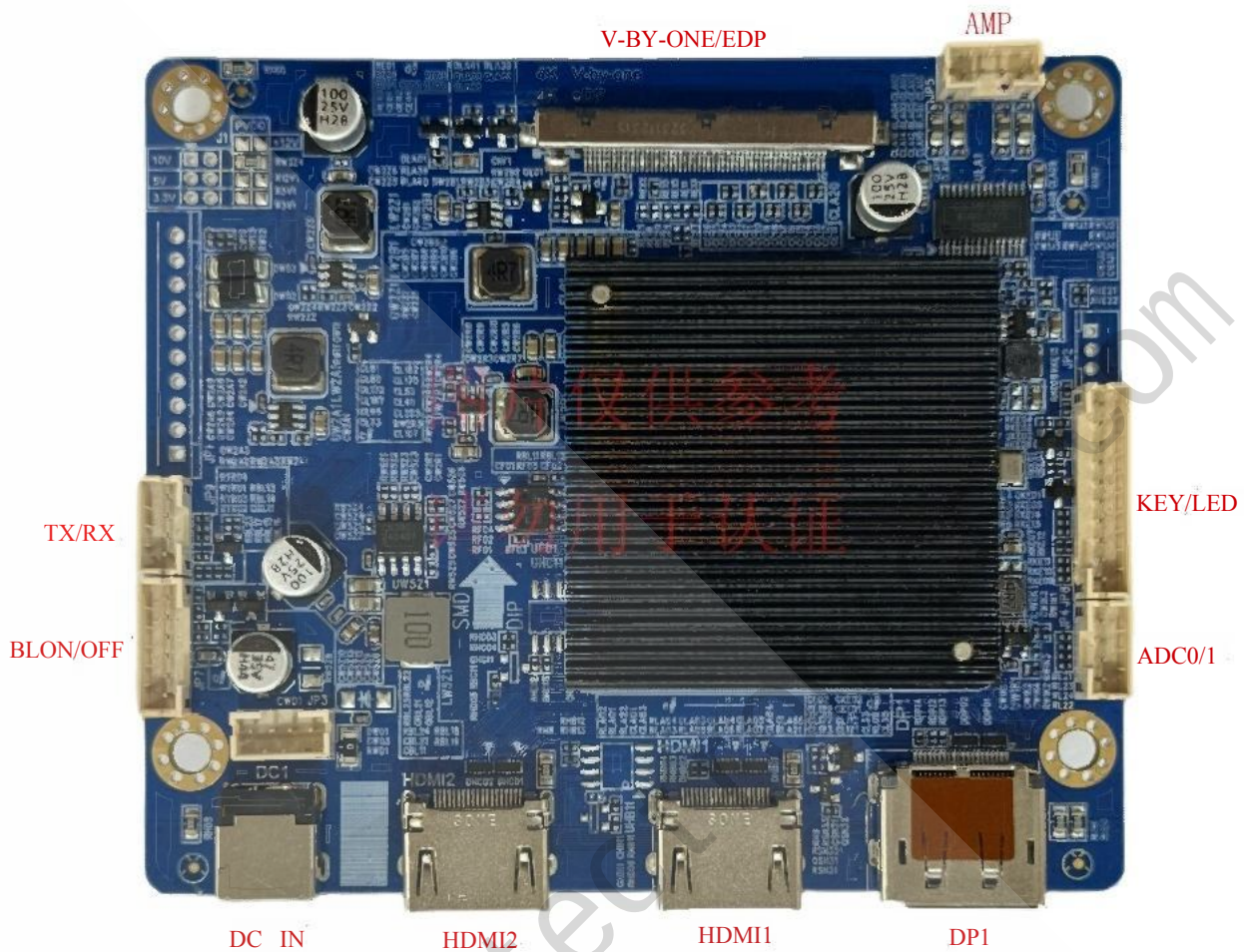


3. Main features (主要特性)

Master Chip 芯片	RTD27XXT-CG		
Signal 信号	HDMI 高清接口	HDMI2 Up To 4096*2160@30Hz HDMI1.4 version (3GHz) MHL2.1(3GHz) HDCP (1.4)	
	DP DP 接口	Up To 4096*2160@60Hz Display Port1.2(5.4Ghz,HBR2)	
	Panel Interface 屏接口	V-By-One/e DP	8LANE VByOne/8LANE eDP/4LANE eDP 8LANE V-BY-ONE,8LANE EDP,4LANE EDP 屏
Audio 音频	Frequency Response 频率响应	100Hz~15K Hz @±3dB(1KHz 0dB Reference Signal) (参考信号频率为 0dB, 1KHZ)	
	Max Output Power 最大输出功率	2×10W(8Ω) THD+N<10%@1KHz (Supply Voltage: 12V, Audio Input: 0.5V _{RMS}) (供电电压: 12V, 音频输入: 0.5V _{RMS})	
Power 电源	Power Supply 输入电源	Support 12V OR 24V DC 支持 12V 或 24V 直流输入	
	Drive screen 驱屏电压	Support 12V,10V,5V,3.3V; Default 10V. 支持 12V,10,5V,3.3V 可选; 默认 10V。	
	Working mode 工作模式	Normal working mode, Low power operating mode 正常工作模式, 低功耗工作模式	
	Standby Power 待机功耗	< 0.25W, 小于 0.25W	
Key 按键	OSD Menu OSD 菜单	Brightnee,Contrsat ratio, Automatic calibration,Phase,Clock,Venue location,Function settings,Reset:亮度, 对比度, 自动校正, 相位, 时钟, 行场位置, 功能设置, 复位等	
	OSD Language OSD 语言	Chinese,English,French,German,Italian,Spanish,Russian,Korean,Japanese:中文, 英语, 法语, 德语, 意大利语, 西班牙语, 俄语, 韩语, 日语等	
	Key Functions 按键功能	POWER、MENU、UP、DOWN、SOURCE、LEFT、RIGHT 电源, 菜单, 上, 下, 信号源, 左, 右	



4.BOARD PICTURE(板卡外观图)

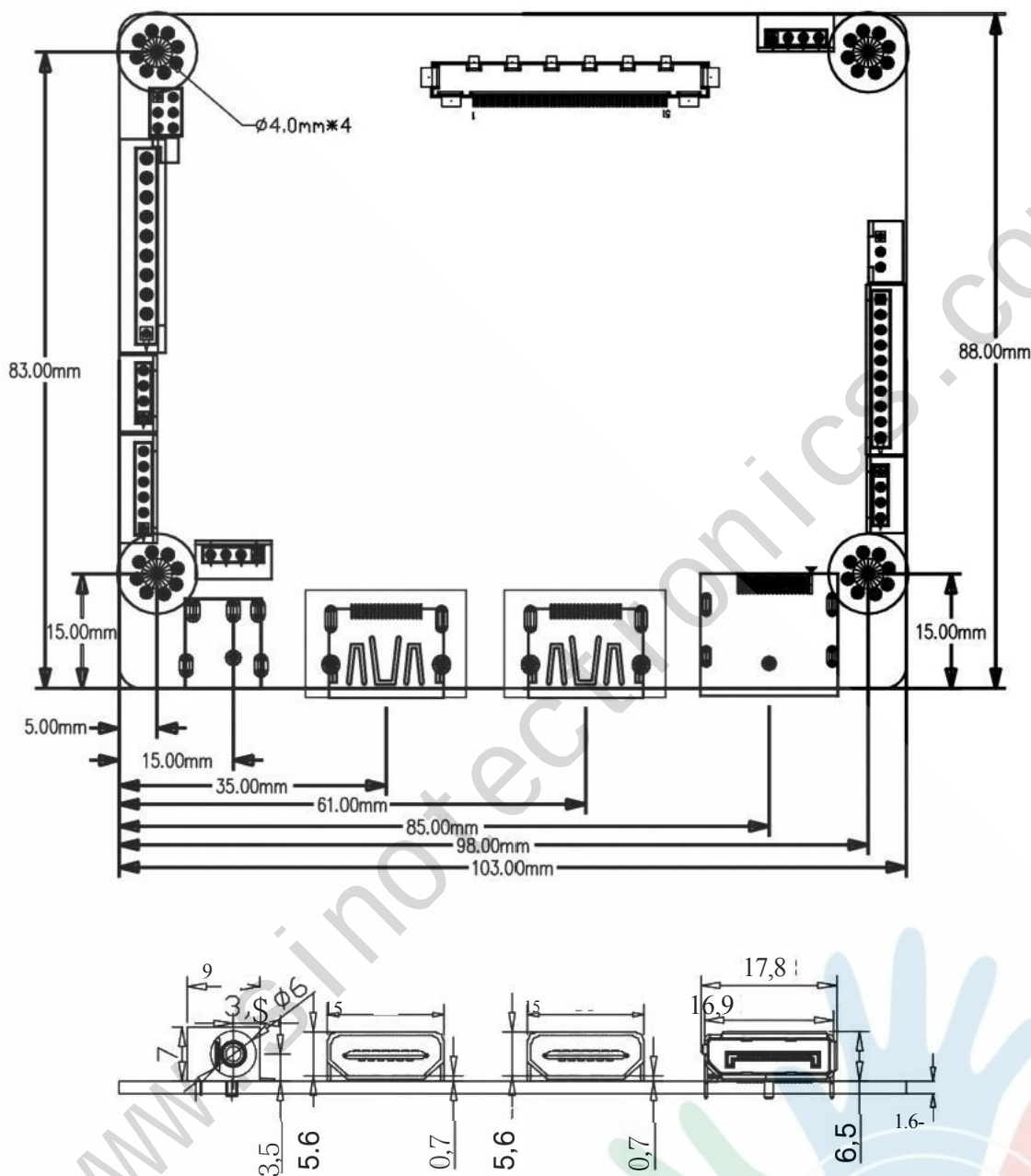


Pictures are for reference only,specific to prevail in kind

图片仅供参考，请以实物为准。



5.PCB Dimension(结构尺寸图)



unit:mm(单位: mm)

控制板PCB 相关尺寸及规格

- 1、PCB 厚度+最高零件的高度 $\leq 16\text{mm}$
- 2、PCB 长度=103mm
- 3、PCB 宽度=88mm
- 4、PCB 板厚=1.6 mm

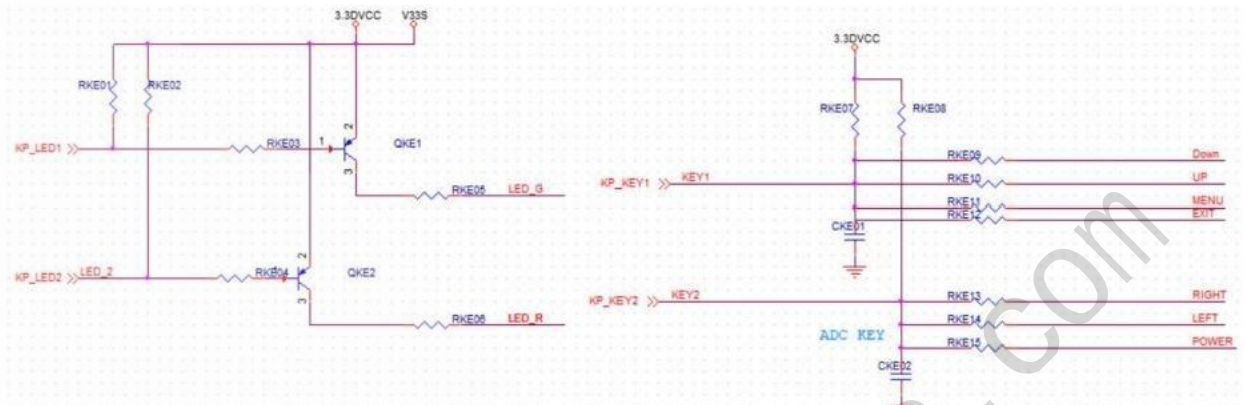
螺丝孔规格: 直径4.0mm 螺丝孔, 孔位大小及坐标见结构图



6.Schematics Of IR Board &Key Board(遥控&按键的原理图)

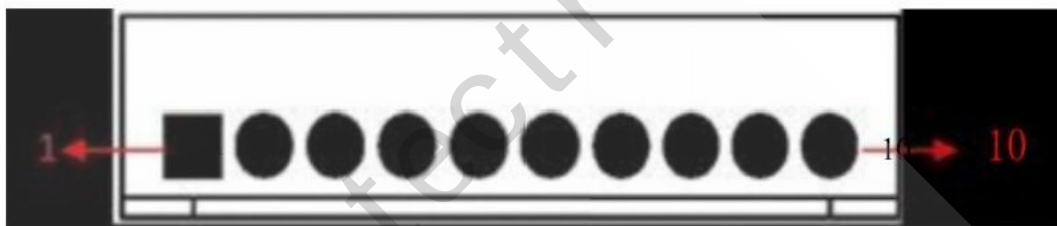
The following schematic is for reference only:

下列原理图仅供参考:



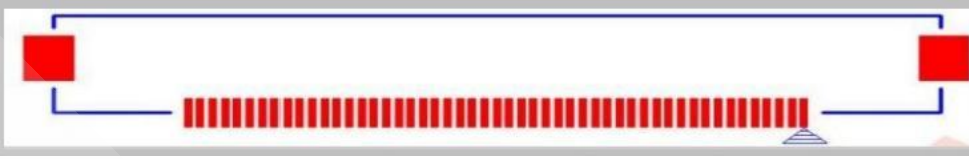
7.Interface Definition(接口定义)

7.1 JP8(10PIN/2.0):IR &KEY BOARD CONNECTOR(按键控制接口)



NO.(引脚)	Symbol(定义)	Description(描述)
1	POWER	Power(电源开关)
2	LED_R	Red LED(红色LED)
3	LED_G	Green LED(绿色LED)
4	GND	Ground(地)
5	K1	按键信号输入
6	K2	按键信号输入
7	K3	按键信号输入
8	K4	按键信号输入
9	K5	按键信号输入
10	K6	按键信号输入



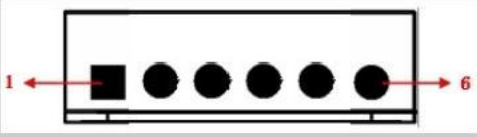
		
NO.(引脚)	Symbol(定义)	Description(描述)
1	VSEL	Power Supply for Panel
2	VSEL	
3	VSEL	
4	VSEL	
5	VSEL	
6	VSEL	
7	VSEL	
8	VSEL	
9	NC	NC
10	GND	Ground(地)
11	GND	
12	GND	
13	GND	
14	GND	
15	TX1_AUX_N_1	eDP Aux 1 Channel-
16	TX1_AUX_P_	eDP Aux 1 Channel+
17	2D/3D_EN	2D/3D_EN
18	I2C0_SDA#	I2C Data signal
19	I2C0_SCL#	I2C Clock signal
20	NC	NC
21	NC	NC
22	NC	NC
23	TX1_AUX_P_2	eDP Aux 2 Channel+
24	TX1_AUX_N_2	eDP Aux 2 Channel-
25	EDPTX1 HPD_1	VBY Hot plug detect /eDP Hot plug detect(1 channel)
26	LOCKN#	VBY Lock detect input/eDP Hot plug detect(2 channel)
27	GND	Ground(地)
28	VTX-TX0P	VBY output data lane0-/eDP data lane0-/eDP HBR2 lane0-(1 channel)
29	VTX-TX0N	VBY output data lane0+/eDP data lane0+/eDP HBR2 lane0+(1 channel)



30	GND	Ground(地)
31	VTX-TX1P	VBV output data lane0-/eDP data lane1-/eDP HBR2 lane1-(1 channel)
32	VTX-TX1N	VBV output data lane0+/ eDP data lane1+/eDP HBR2 lane1+(1 channel)
33	GND	Ground(地)
34	VTX-TX2P	VBV output data lane0-/eDP data lane2-/eDP HBR2 lane2-(1 channel)
35	VTX-TX2N	VBV output data lane0+/ eDP data lane2+/eDP HBR2 lane2+(1 channel)
36	GND	Ground(地)
37	VTX-TX3P	VBV output data lane0-/eDP data lane3-/eDP HBR2 lane3-(1 channel)
38	VTX-TX3N	VBV output data lane0+/ eDP data lane3+/eDP HBR2 lane3+(1 channel)
39	GND	Ground(地)
40	VTX-TX4P	VBV output data lane0-/eDP data lane4-/eDP HBR2 lane4-(1 channel)
41	VTX-TX4N	VBV output data lane0+/ eDP data lane4+/eDP HBR2 lane4+(1 channel)
42	GND	Ground(地)
43	VTX-TX5P	VBV output data lane0-/eDP data lane5-/eDP HBR2 lane5-(1 channel)
44	VTX-TX5N	VBV output data lane0+/ eDP data lane5+/eDP HBR2 lane5+(1 channel)
45	GND	Ground(地)
46	VTX-TX6P	VBV output data lane0-/eDP data lane6-/eDP HBR2 lane6-(1 channel)
47	VTX-TX6N	VBV output data lane0+/ eDP data lane6+/eDP HBR2 lane6+(1 channel)
48	GND	Ground(地)
49	VTX-TX7P	VBV output data lane0-/eDP data lane7-/eDP HBR2 lane7-(1 channel)
50	VTX-TX7N	VBV output data lane0+/ eDP data lane7+/eDP HBR2 lane7+(1 channel)
51	GND	Ground(地)



7.3 JP7(6PIN/2.0):INVERTER CONNECTOR(背光接口)

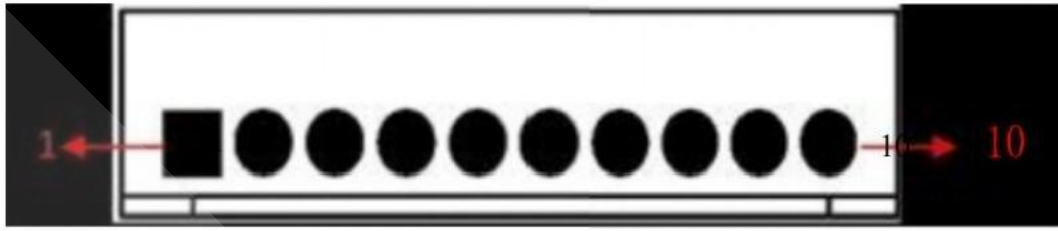
		
NO.	SYMBOL	DESCRIPTION
	12V	+12V DC Power Supply
2	12V	+12V DC Power Supply
3	ON/OFF	Back Light ON/OFF
4	ADJ	Back Light Adjust
5	GND	Ground
6	GND	Ground

7.4 JP5(4PIN/2.0):SPEAKER(喇叭接口)

		
NO.(引脚)	Symbol(定义)	Description(描述)
1	LOUTP	Left Channel Output+(左声道输出+)
2	LOUTN	Left Channel Output-(左声道输出-)
3	ROUTN	Right Channel Output-(右声道输出-)
4	ROUTP	Right Channel Output+(右声道输出+)

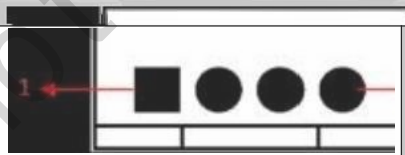


7.5 JP1(10PIN/2.54)External Power Input Definition(供电接口)



NO.(引脚)	Symbol(定义)	Description(描述)
1	STB	STB
2	GND	Ground(地)
3	GND	Ground(地)
4	STB-5V	STB-5V
5	+5V	NOR-5V
6	+5V	NOR-5V
7	GND	Ground(地)
8	GND	Ground(地)
9	12V	+12VDCPowerSupply
10	12V	+12VDCPowerSupply

7.6 JP9 (4PIN/2.0):UART(串口接口)



NO.(引脚)	Symbol(定义)	Description(描述)
1	+5V	+5V DCPowerSupply
2	RX	UART-RX
3	TX	UART-TX
4	GND	Ground(地)



8. Packaging method(包装方式)

防静电袋(如下图)尺

寸: 130mm×160mm

数量: 每包1PCS



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环境实验报告

Environment Test Report

目 录

1. 测试仪器 / TEST EQUIPMENT	14
2. 测试目录 / LIST OF TEST ITEMS	14
3. 环境测试 / TEST OF ENVIRONMENTAL	15
3.1. 低温启动 / Low Temperature Startup	15
3.2. 低温贮存 / Low Temperature Store	15
3.3. 高温高湿贮存 / High Temperature High Humidity Store	16
3.4. 高低温冲击实验 / High Low Temperature Pressure Impact Test	16
3.5 低温工作测试 / Low Temperature Operating Test	17
3.6 高温高湿工作测试 / High Temperature High Humidity Operating Test	18
3.7 高低温循环工作测试 / High Low Temperature Cycling Operating Test	18 ,19



1. 测试仪器 / Test Equipment

序号 / No	功用名称 / Function Name	型号 / Model
1	直流耦合电流探头/ DC Split Core Current Oscilloscope	Tektronix TCP202
2	无源电压探头/ Passive Voltage Probe	Tektronix NC600
3	高压差分探头/ Passive High Voltage Probe	Tektronix HP9258
4	交流源/ AC Source	EXTECH 6600
5	功率计/ Power Meter	Zentech 2100 Chroma6630
6	数字示波器/ Digital Oscilloscope	Tektronix TDS3012B
7	直流电子负载/ DC Electronic Load	JARTUL JT6315A
8	数字万用表/ Digital Multimeter	Fluke 101
9	数据采集仪/ Data Acquisition	Fluke 45
10	程式恒湿恒温实验机/ Programmable Temperature Humidity	GZ-ESPEC MPC-2000A

2. 测试目录 / List of Test Items

序号 / No.	项目 / Items	结果 / Result	备注 / Remark
1	低温启动/ Low Temperature Startup	PASS	
2	低温贮存/ Low Temperature Store	PASS	
3	高温高湿贮存/ High Temperature High Humidity Store	PASS	
4	高低温冲击实验/ High Low Temperature Pressure Impact Test	PASS	
5	低温工作测试/ Low Temperature Operating Test	PASS	
6	高温高湿工作测试/ High Temperature High Humidity Operating Test	PASS	
7	高低温循环测试/ High Low Temperature Cycling	PASS	

负载表/Load Table

	Remark
Full Load	模拟整机正常播放 Simulate the Monitor to play normally
Min Load	/

3. 环境测试/Test of Environmental

3.1. 低温启动/Low Temperature Startup

测试条件/Test Condition:

环境温度 /Ambient Temperature	时间 /Time	输入电压 /Input Voltage	负载 /Load
-15℃	2h	DC 24V	Full Load

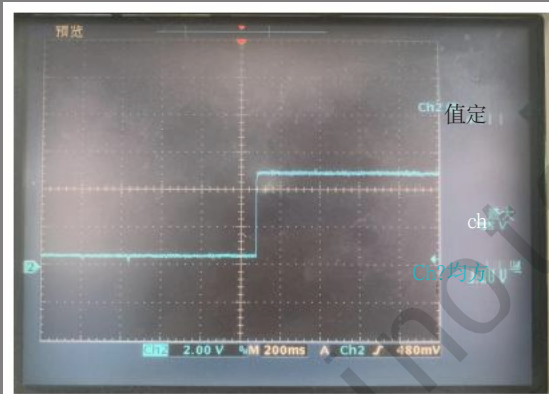
测试规格/Test Spec.

产品在低温下能够正常启动并稳定工作，主要性能和功能指标要满足规格书要求

The product can start normally and work stably at low temperatures, and the main performance and functional indicators must meet the requirements of the specification

测试数据/Test Data.

环境温度 Ambient Temperature	时间/Time	输入电压 /Input Voltage	启动状况 /Status of the Start up	图号/Fig No.	结果/Result
-15℃	2h	DC 24V	启动正常 start normally	3.1-1	PASS

					
DC 24V 3.1-1					

3.2. 低温贮存/Low Temperature Store

测试条件/Test Condition:

环境温度 /Ambient Temperature	持续时间 Duration	输入电压 /Input Voltage	负载 /Load
-40℃ ± 3℃	16h	DC 24V	Full Load

测试规格/Test Spec.

产品在低温贮存后，恢复常温下静置1-2小时后，主要性能和功能指标要满足规格书要求

After the product is stored at low temperature, after returning to normal temperature and letting it stand for 1-2 hours, the main performance and functional indicators shall meet the requirements of the specification



测试数据/Test Data.

环境温度 / Ambient Temperature	持续时间 / Duration	结果 /Result
-40℃	16h	PASS

3.3. 高温高湿贮存 / High Temperature High Humidity Store

测试条件/Test Condition:

环境温度 / Ambient Temperature	相对湿度 / Relative Humidity	持续时间 / Duration	输入电压 / Input Voltage	负载 / Load
80℃	95%	16h	DC 24V	Full Load

测试规格/Test Spec.

产品在高温高湿贮存后，恢复常温下静置 1-2 小时后,主要性能和功能指标要满足规格书要求

After the product is stored in high temperature and high humidity, after returning to normal temperature and letting it stand for 1-2 hours, the main performance and functional indicators shall meet the requirements of the specification

测试数据/Test Data.

环境温度 / Ambient Temperature	相对湿度 / Relative Humidity	持续时间 /Duration	结果 /Result
80℃	95%	16h	PASS

3.4. 高低温冲击实验 / High Low Temperature Pressure Impact Test

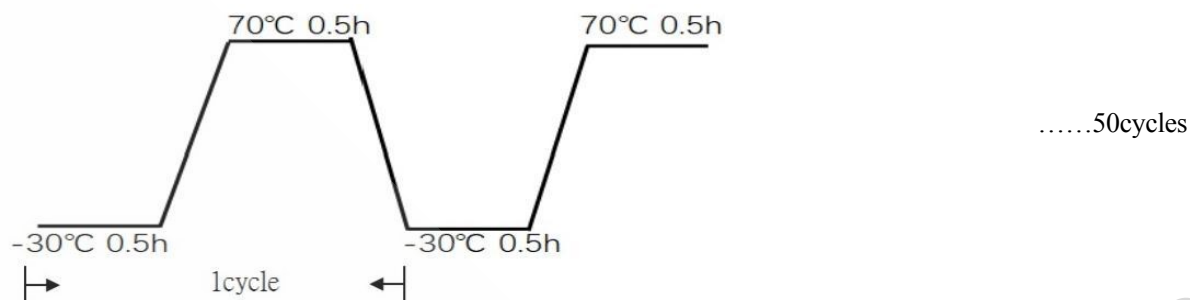
测试条件/Test Condition:

环境温度 / Ambient Temperature	相对湿度 / Relative Humidity	温度变化速率 /Temperature Change Speed	时间 / Time	次数 /cyclng
70℃	-	40℃ -45℃/min	0.5h	50
-30℃	-		0.5h	

测试规格/Test Spec.

产品在上下限温度切换贮存后，恢复常温下静置 1-2 小时后，主要性能和功能指标要满足规格书要求

After the product is stored at the upper and lower limit temperature, after returning to normal temperature and letting it stand for 1-2 hours, the main performance and functional indicators shall meet the requirements of the specification



测试数据/Test Data.

环境温度 /Ambient Temperature	时间 /Time	次数 /cycling	结果 /Result
-30℃&70℃	50h	50	PASS

3.5 低温工作测试/Low Temperature Operating Test

测试条件/Test Condition:

输入电压 /Input Voltage	负载 /Load	环境温度 /Ambient Temperature	时间 /Time
DC 24V	Full Load	-15℃	8h

测试规格/Test Spec

测试产品在低温工作时，主要性能和功能指标要满足规格书要求

When the test product is working at low temperature, the main performance and functional indicators must meet the requirements of the specification

测试数据/Test Data.

输入电压 /Input Voltage	负载 /Load	环境温度 /Ambient Temperature	时间 /Time	结果 /Result
DC 24V	Full Load	-15℃	8h	PASS

输出短路保护/Output short circuit protection

输入电压 /Input Voltage	负载 /Load	Short Channel			结果 /Result
		/			
/	/	自动恢复Automatic recovery			/



3.6 高温高湿工作测试 / High Temperature High Humidity Operating Test

测试条件/Test Condition:

输入电压 /Input Voltage	负载 / Load	环境温度 / Ambient Temperature	相对湿度 / Relative Humidity	时间 / Time
DC 24V	Full Load	45°C	90%	8h

测试规格/Test Spec.

When the test product is working at high temperature and high humidity, the main performance and functional indicators must meet the requirements of the specification

测试数据/Test Data.

输入电压 /Input Voltage	负载 / Load	环境温度 /Ambient Temperature	相对湿度 / Relative Humidity	时间 / Time	结果 /Result
DC 24V	Full Load	45°C	90%	8h	PASS

输出短路保护/ Output short circuit protection

输入电压 /Input Voltage	负载 / Load	Short Channel			结果 /Result
		12V	\	\	
DC 24V	Full Load	自动恢复	\	\	PASS

3.7 高低温循环工作测试 / High Low Temperature Cycling Operating Test

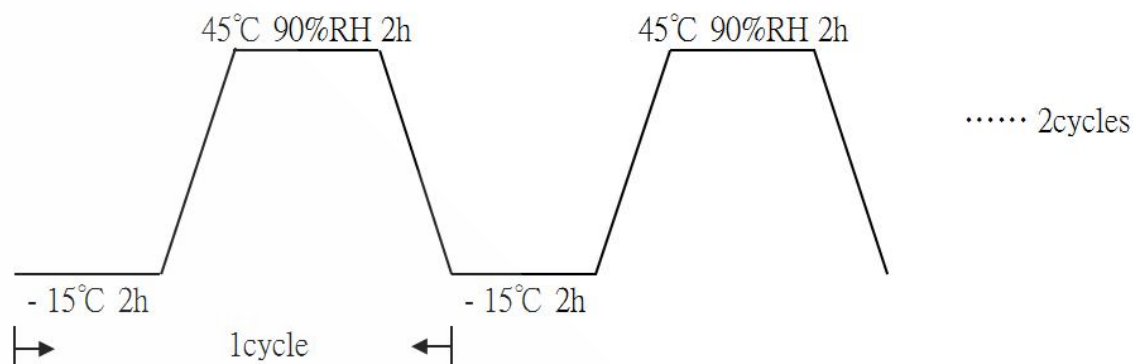
测试条件/Test Condition:

环境温度 / Ambient Temperature	相对湿度 / Relative Humidity	温度变化速率 /Temperature Change Speed	次数 /cycling	时间 / Time	输入电压 / Input Voltage	负载 / Load
45°C	90%	1°C-5°C/min	2	2h	DC 24V	Full Load
-15°C	-			2h		

测试规格/Test Spec.

产品在上下限温度切换工作时，主要性能和功能指标要满足规格书要求

When the product is switched between the upper and lower temperature limits, the main performance and functional indicators must meet the requirements of the specification



测试数据/Test Data.

输入电压 /Input Voltage	环境温度 /Ambient Temperature	时间 /Time	结果 /Result
DC 24V	-15°C&45°C	8h	PASS

END.